

## ightarrow ightarrow ightarrow Inductors (Coils) ightarrow Detailed Information

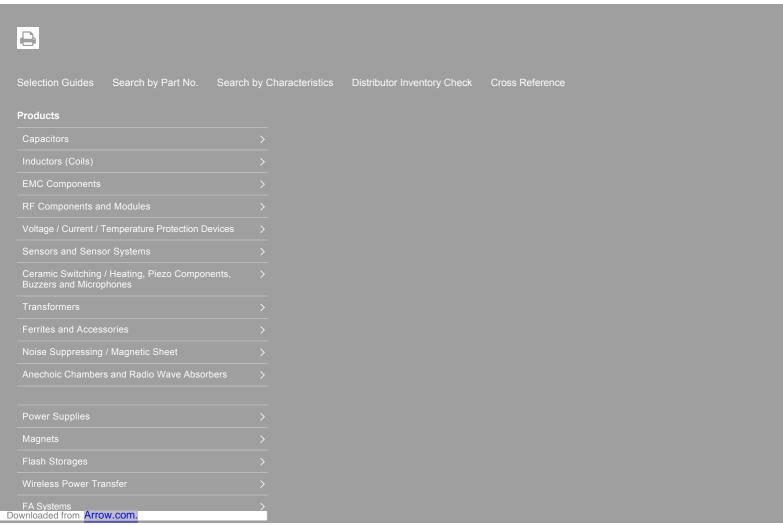
## Inductors (Coils)

Product Top Pa	ge Search by Part No.	Search by Characteristics	Cross Reference	Catalog	Tech Notes	▼ more
MHQ04	02P1N2BT	000				Rehts SVHC-Free Free Free
Applications	Commercial Grad	le				PDF file of this page
Feature	Non-Mag Core Non-Mag	n-Mag Core Non-Magnetic Core (Dielectric Ceramic)		→ → → → → → → → → → → → → → → → → → →		Contact
Series   Type	Zpe MHO-P					Documents
Status	Production (Not Recommended for New Desi Recommended Alternate Part No. : <u>MHQ0402PSA</u> hangeability is not guaranteed.)		and show exemplary p		-	
Brand TDK						Product Lineup
						[Selection Guide] Inductors for high frequency applications Update
Size						Sample Kits
		0.44	)?mm			
Length(L)			0.44mm ±0.02mm			Technical Support Tools
Width(W)			0.24mm ±0.02mm			SPICE Netlist (Simple)
Thickness   Hei	-		0.24mm ±0.02mm			SPICE Netlist (Precision)
Recommended Land Pattern (A)			0.15mm to 0.20mm			Equivalent Circuit Model
Recommended Land Pattern (B) Recommended Land Pattern (C)			0.20mm Nom.			
Recommended		0.18mm to 0	.2011111			
Electrical Cha	racteristics					
Inductance		1.2nH ±0.1nl	1.2nH ±0.1nH at 500MHz			
Rated Current		320mA	320mA			
DC Resistance [Typ.]		120mΩ				
DC Resistance	[Max.]	200mΩ				
Self Resonant I	Frequency [Min.]	9GHz	9GHz			
Self Resonant F	Frequency [Typ.]	11.8GHz	11.8GHz			
Q [Min.]		10 at 500MH	10 at 500MHz			
Q [Тур.]		15 at 500MH	15 at 500MHz			
Other						
Operating Temp	o. Range (Including Self-Te	emp. Rise) -55 to 125°C				
Soldering Method		Reflow	Reflow			
AEC-Q200 No						
Packing Punched		Punched (Pa	d (Paper)Taping [180mm Reel]			
Package Quantity		20000pcs				
Weight		0.00011a	0.00011g			

characteristics.)

Impedance

MHQ0402P1N2BT000	MHQ0402P1N2BT000
Change settings	Change settings
Inductance	Q
MHQ0402P1N2BT000	MHQ0402P1N2BT000
Change settings	Change settings



Transparent Conductive Film	>	
Micro Modules (Substrates with Built-in ICs, Products Utilizing with SESUB)		
Solar Cells		
Biosensor		
Application Specific IC (ASIC) Development and Supply		
Application Guides		
Technical Support		
Tech Library		
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